%Machine Details:

S650 Double Spray Etc	ching Machine	
Power	5.5KW/220V/50HZ	
Working width	650mm	
Etching area	650*1000mm	
Etched type	Double Spraying	
Working Temperature	37~45°C	
Heat System	Titanium,3KW	
Cool System	PE cooling Pipe,25 meter	
Vertical Pump	2.2KW/220V/50HZ	
Spray Pipe	8pcs for up, 8pcs for down	
Nozzles	Fan-type nozzles, total 104pcs	
Machine material	15mm PP plate, resit high temperature	
Machine Size/weight	2250*1450*1250mm / 350kgs	
Automatic Control Syste	em:	1
Speed and Pressure Adju Net Filter System	ust System Temperature control Long times Etching	
	nachine can produce metal nameplate teel, Copper, Brass, Aluminum,titaniu	logos,medals,signs or other metal plate. Materials, m and so on.

*** Etching Process:**

1)Computer designs and Output negative film

2)Degreasing, Use Plastic Tank, clean the plate surface to get a good situation for coat photoresist.

It takes about 2~3 minutes.

3) Coat photo resist by spray gun or photoresist coating machine.

4)Expose. Use exposure machine, the exposing light will transfer the images masks on metal plate.

It takes 20~30seconds.

5) Developer, Use Plastic Tank, removing the unnecessary masks where will be etched down. You can do it by hand, usually it takes 3~5 minutes; you can also choose developing machine.

6), Etching. Use etching machine, removing of unwanted metal which expose to chemical solution.

It takes 2~3 minutes.

(If you want to coating color, you can use color coating machine, after that you should drying the plate then stripping)

7), Stripping. Remove all the photo resist ink; use SST or Plastic Tank to finish it.

The process is similar to developing process, only chemical is different.

8)Forming and finishing operations.